PhotoTechEDU series

Lecture 05: Feb. 21, 2007 Silicon image sensors

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A good source of tutorials and papers: York University VISOR Laboratory http://www.cse.yorku.ca/~visor/pubs.html

Short Course Notes

Two-day short course presented at the Waterloo Institute for Computer Research, May 1999.

- Background and Principles of Optical Detection
- Fabrication Technology and Pixel Design
- Noise in Image Sensors
- Imaging System on a Chip
- Appendix A CMOS Fabrication Technology
- Appendix B CCD Technology
- Appendic C Other sensor types

Silicon crystal: the closest thing to magic that we'll need

n



	boron	carbon	nitrogen	oxygen
	5	6	7	8
	В	С	N	0
	aluminium	silicon	phosphorus	sulfur
	13	14	15	16
	AI	Si	Р	S
•	gallium	germanium	arsenic	seleniun
	31	32	33	34
1	Ga	Ge	As	Se
um	indium	tin	antimony	tellurium
	49	50	51	52
		•	01	-
	In	Sn	Sb	le



"I therefore take the liberty of proposing for this hypothetical new atom, which is not light but plays an essential part in every process of radiation, the name *photon*." —Gilbert N. Lewis, *Nature* 1926

Photodiode (reverse-biased PN junction) and Image Sensor





Electron-hole pair generation and separation in a reverse-biased PN junction

(Tobi Delbrück and Jörg Kramer chapter in Analog VLSI: Circuits and Principles)



Figure 10.1

Principle of operation of a photodiode. Electron-hole pairs generated by incident photons in or within a diffusion length outside the depletion region become separated and contribute to a reverse generation current.

Cross-section of a pixel sensor on a silicon substrate



FIG. 12B

Light Quanta: Photons # can be computed using energy per quantum

$$E = hv = \frac{hc}{\lambda}$$

E = photon energy

1

$$v =$$
 frequency of light

- λ = wavelength of light
- $c = 3 \times 10^8$ m/s speed of light
- $h = 6.626 \times 10^{-34} \text{ J} \cdot \text{s}$ Planck's constant
- $h = 4.135 \times 10^{-15} \text{ eV} \cdot \text{s}$ Planck's constant

Other things can be computed, too; for example, the wavelength corresponding to Silicon's bandgap energy:

E = 1.12 eV is Silicon's bandgap energy Wavelength $\lambda = (h \cdot c)/E$

= (4.135•10⁻¹⁵ eV s • 3•10⁸ m/s)/1.12 eV

= 1110 nm (compare to 400–700 nm visible range) which means that photons corresponding to longer (infra-red) wavelengths do not have enough energy to kick an electron up from the valence band to the conduction band; the silicon is transparent to these long waves Interaction strength and penetration depth depend on wavelength; photon absorptions are independent events



5 µm

Photon shot noise: example histogram of event counts, 1000 trials, mean rate 10 independent events per trial



Classic 3-transistor active pixel sensor



Array architecture of an image sensor: Foveon F19





Sensor noise sources

- Photon shot noise (variance = count)
- Reset noise at photodiode capacitance (charge variance = kTC)
- PRNU: photo-response non-uniformity
- Dark-offset fixed pattern
- Readout amplifier thermal and 1/f noise
- Dark current and its shot noise
- ADC quantization noise (variance = 1/12 (LSB)²)
- ADC differential nonlinearity
- Pickup of stray EM interference

Noise in electrons

- Convert all noises to input-referred electrons
- Add up variances (in electrons²)
- Plot it all versus signal electrons, since dominant noise changes over the range
- Only the largest few noise sources matter, so try to reduce or cancel those
- Convert outputs to electrons using gains like µV/e⁻, DN/e⁻

4-T pixel sensor allows reset noise cancellation via correlated double sampling





Low SNR: Signal = $4e^-$ with Poisson Noise; Read Noise = $2e^-$ Read Noise = $4e^$ net SNR = 1.4 net SNR = 0.9



Kodak KAI-11002 (interline-transfer CCD) pixel architecture



True Two Phase Burried Channel VCCD Lightshield over VCCD not shown





n Substrate

Cross Section Through Photodiode and VCCD Phase 2 at Transfer Gate



n	n
Substrate	Substrate

CMOS and CCD sensor architectures



CMOS pixel arrays are fabricated with standard silicon processes, enabling peripheral electronics to be included on the chip.

Kodak KAI-11000 pixel cross-section



Figure 2: Pixel Architecture

Quantum Efficiency Color with Microlens Quantum Efficiency

Quantum Efficiency: electrons per photon



Figure 10: Color with Microlens Quantum Efficiency Using AR Glass

QE Color without Microlens Quantum Efficiency shows 2.5X microlens gain (implies about 40% fill factor)



CCD Angle of Incidence Problem: loss of quantum efficiency at high angles due to light missing the photodiode active area



Angular Quantum Efficiency

For the curves marked "Horizontal", the incident light angle is varied in a plane parallel to the HCCD. For the curves marked "Vertical", the incident light angle is varied in a plane parallel to the VCCD.

Monochrome with Lenslets

Angle QE– Rectangular photodiode leads to different X and Y sensitivity



Figure 14: Monochrome with Lenslets Angular Quantum Efficiency







Sampling and aliasing: a test image with lots of frequencies





Same test image, but blurred



Optical low-pass (AA) filter attenuates high frequencies before they can alias

(from Image Sensors and Signal Processing for Digital Still Cameras)



FIGURE 2.10 Example of the MTF for (a) an imaging lens and (b) a typical OLPF.

CFA can lead to color moiré



Bayer CFA moiré detail



Luminance artifacts tend to be fine, grid-like



Luma is recoverable when chroma is known



The "-els" according to Holst

Table 1-4 THE "-ELS"

ELEMENT	DESCRIPTION
Scenel (Scene element)	A sample created by a scene simulator. Because the data resides in a computer memory, the array size is equal to the number of scenels.
Pixel or pel (picture element)	A sample created by a detector.
Datel (data element)	Each datum is a datel. Datels reside in a computer memory.
Disel (display element)	The smallest element (sample) that a display medium can access.
Resel (resolution element)	The smallest signal supported by an analog system.

Radiometry: light power

SI radiometry units

Quantity	Symbol	SI unit	Abbr.	Notes
Radiant energy	Q	joule	J	energy
Radiant flux	Φ	watt	w	radiant energy per unit time, also called radiant power
Radiant intensity	I.	watt per steradian	W·sr-1	power per unit solid angle
Radiance	L	watt per steradian per square metre	W·sr-1·m-2	power per unit solid angle per unit <i>projected</i> source area. Sometimes confusingly called "intensity".
Irradiance	E	watt per square metre	W·m-²	power incident on a surface. Sometimes confusingly called "intensity".
Radiant exitance / Radiant emittance	м	watt per square metre	W·m-²	power emitted from a surface. Sometimes confusingly called "intensity".
Spectral radiance	L _λ or L _v	watt per steradian per metre ³ or watt per steradian per square metre per hertz	W·sr ⁻¹ ·m ⁻³ <i>or</i> W·sr ⁻¹ ·m ⁻² ·Hz ⁻¹	commonly measured in W·sr-1·m-2·nm-1
Spectral irradiance	Ε _λ or Ε _ν	watt per metre ³ <i>or</i> watt per square metre per hertz	W·m ⁻³ <i>or</i> W·m ⁻² ·Hz ⁻¹	commonly measured in W·m ⁻² ·nm ⁻¹



Photometry: light visibility

SI photometry units

Quantity	Symbol	SI unit	Abbr.	Notes
Luminous energy	Q _v	lumen second	lm∙s	units are sometimes called Talbots
Luminous flux	F	lumen (= cd·sr)	Im	also called <i>luminous power</i>
Luminous intensity	l _v	candela (= lm/sr)	cd	an SI base unit
Luminance	Lv	candela per square metre	cd/m ²	units are sometimes called nits
Illuminance	Ev	$lux (= lm/m^2)$	Ix	Used for light incident on a surface
Luminous emittance	Mv	lux (= lm/m ²)	Ix	Used for light emitted from a surface
Luminous efficacy		lumen per watt	lm/W	ratio of luminous flux to radiant flux; maximum possible is 683.002